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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	2016
Number of Logic Elements/Cells	-
Total RAM Bits	18432
Number of I/O	168
Number of Gates	125000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	324-BGA
Supplier Device Package	324-FBGA (19x19)
Purchase URL	https://www.e-xfl.com/product-detail/microsemi/ax125-fg324

User-Defined Supply Pins

VREF **Supply Voltage**

Reference voltage for I/O banks. VREF pins are configured by the user from regular I/O pins; VREF pins are not in fixed locations. There can be one or more VREF pins in an I/O bank.

Global Pins

HCLKA/B/C/D **Dedicated (Hardwired) Clocks A, B, C and D**

These pins are the clock inputs for sequential modules or north PLLs. Input levels are compatible with all supported I/O standards. There is a P/N pin pair for support of differential I/O standards. Single-ended clock I/Os can only be assigned to the P side of a paired I/O. This input is directly wired to each R-cell and offers clock speeds independent of the number of R-cells being driven. When the HCLK pins are unused, it is recommended that they are tied to ground.

CLKE/F/G/H **Routed Clocks E, F, G, and H**

These pins are clock inputs for clock distribution networks or south PLLs. Input levels are compatible with all supported I/O standards. There is a P/N pin pair for support of differential I/O standards. Single-ended clock I/Os can only be assigned to the P side of a paired I/O. The clock input is buffered prior to clocking the R-cells. When the CLK pins are unused, Microsemi recommends that they are tied to ground.

JTAG/Probe Pins

PRA/B/C/D **Probe A, B, C and D**

The Probe pins are used to output data from any user-defined design node within the device (controlled with Silicon Explorer II). These independent diagnostic pins can be used to allow real-time diagnostic output of any signal path within the device. The pins' probe capabilities can be permanently disabled to protect programmed design confidentiality. The probe pins are of LVTTL output levels.

TCK **Test Clock**

Test clock input for JTAG boundary-scan testing and diagnostic probe (Silicon Explorer II).

TDI **Test Data Input**

Serial input for JTAG boundary-scan testing and diagnostic probe. TDI is equipped with an internal 10 kΩ pull-up resistor.

TDO **Test Data Output**

Serial output for JTAG boundary-scan testing.

TMS **Test Mode Select**

The TMS pin controls the use of the IEEE 1149.1 boundary-scan pins (TCK, TDI, TDO, TRST). TMS is equipped with an internal 10 kΩ pull-up resistor.

TRST **Boundary Scan Reset Pin**

The TRST pin functions as an active-low input to asynchronously initialize or reset the boundary scan circuit. The TRST pin is equipped with a 10 kΩ pull-up resistor.

Special Functions

LP **Low Power Pin**

The LP pin controls the low power mode of Axcelerator devices. The device is placed in the low power mode by connecting the LP pin to logic high. To exit the low power mode, the LP pin must be set Low. Additionally, the LP pin must be set Low during chip powering-up or chip powering-down operations. See "Low Power Mode" on page 2-106 for more details.

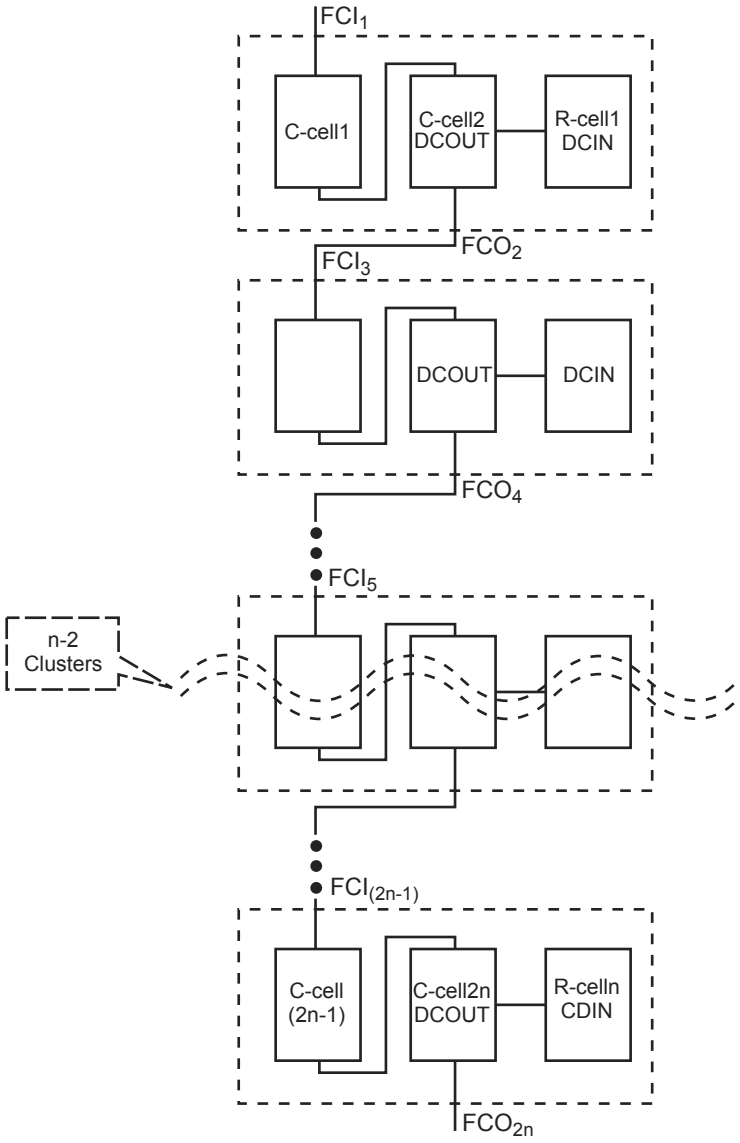
NC **No Connection**

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

Timing Characteristics

***Table 2-35* • 3.3 V PCI I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
3.3 V PCI Output Module Timing								
t_{DP}	Input Buffer		1.57		1.79		2.10	ns
t_{PY}	Output Buffer		1.91		2.18		2.56	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		1.61		1.62		1.63	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		1.45		1.47		1.47	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		2.55		2.90		3.41	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		3.52		4.01		4.72	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns



Note: The carry-chain sequence can end on either C-cell.

Figure 2-30 • **Carry-Chain Sequencing of C-Cells**

Timing Characteristics

Refer to Table 2-62 on page 2-55 for more information on carry-chain timing.

Timing Characteristics

Table 2-65 • AX125 Predicted Routing Delays
Worst-Case Commercial Conditions VCCA = 1.425 V, T_J = 70°C

		–2 Speed	–1 Speed	Std Speed	
Parameter	**Description**	**Typical**	**Typical**	**Typical**	**Units**
Predicted Routing Delays					
t_{DC}	DirectConnect Routing Delay, FO1	0.11	0.12	0.15	ns
t_{FC}	FastConnect Routing Delay, FO1	0.35	0.39	0.46	ns
t_{RD1}	Routing delay for FO1	0.35	0.40	0.47	ns
t_{RD2}	Routing delay for FO2	0.38	0.43	0.51	ns
t_{RD3}	Routing delay for FO3	0.43	0.48	0.57	ns
t_{RD4}	Routing delay for FO4	0.48	0.55	0.64	ns
t_{RD5}	Routing delay for FO5	0.55	0.62	0.73	ns
t_{RD6}	Routing delay for FO6	0.64	0.72	0.85	ns
t_{RD7}	Routing delay for FO7	0.79	0.89	1.05	ns
t_{RD8}	Routing delay for FO8	0.88	0.99	1.17	ns
t_{RD16}	Routing delay for FO16	1.49	1.69	1.99	ns
t_{RD32}	Routing delay for FO32	2.32	2.63	3.10	ns

Table 2-66 • AX250 Predicted Routing Delays
Worst-Case Commercial Conditions VCCA = 1.425 V, T_J = 70°C

		–2 Speed	–1 Speed	Std Speed	
Parameter	**Description**	**Typical**	**Typical**	**Typical**	**Units**
Predicted Routing Delays					
t_{DC}	DirectConnect Routing Delay, FO1	0.11	0.12	0.15	ns
t_{FC}	FastConnect Routing Delay, FO1	0.35	0.39	0.46	ns
t_{RD1}	Routing delay for FO1	0.39	0.45	0.53	ns
t_{RD2}	Routing delay for FO2	0.41	0.46	0.54	ns
t_{RD3}	Routing delay for FO3	0.48	0.55	0.64	ns
t_{RD4}	Routing delay for FO4	0.56	0.63	0.75	ns
t_{RD5}	Routing delay for FO5	0.60	0.68	0.80	ns
t_{RD6}	Routing delay for FO6	0.84	0.96	1.13	ns
t_{RD7}	Routing delay for FO7	0.90	1.02	1.20	ns
t_{RD8}	Routing delay for FO8	1.00	1.13	1.33	ns
t_{RD16}	Routing delay for FO16	2.17	2.46	2.89	ns
t_{RD32}	Routing delay for FO32	3.55	4.03	4.74	ns

***Table 2-69* • AX2000 Predicted Routing Delays**
Worst-Case Commercial Conditions VCCA = 1.425 V, T_J = 70°C

		–2 Speed	–1 Speed	Std Speed	
Parameter	**Description**	**Typical**	**Typical**	**Typical**	**Units**
Predicted Routing Delays					
t_{DC}	DirectConnect Routing Delay, FO1	0.12	0.13	0.15	ns
t_{FC}	FastConnect Routing Delay, FO1	0.35	0.39	0.46	ns
t_{RD1}	Routing delay for FO1	0.50	0.56	0.66	ns
t_{RD2}	Routing delay for FO2	0.59	0.67	0.79	ns
t_{RD3}	Routing delay for FO3	0.70	0.80	0.94	ns
t_{RD4}	Routing delay for FO4	0.76	0.87	1.02	ns
t_{RD5}	Routing delay for FO5	0.98	1.11	1.31	ns
t_{RD6}	Routing delay for FO6	1.48	1.68	1.97	ns
t_{RD7}	Routing delay for FO7	1.65	1.87	2.20	ns
t_{RD8}	Routing delay for FO8	1.73	1.96	2.31	ns
t_{RD16}	Routing delay for FO16	2.58	2.92	3.44	ns
t_{RD32}	Routing delay for FO32	4.24	4.81	5.65	ns

The ClockTileDist Cluster contains an HCLKMux (HM) module for each of the four HCLK trees and a CLKMux (CM) module for each of the CLK trees. The HCLK branches then propagate horizontally through the middle of the core tile to HCLKColDist (HD) modules in every SuperCluster column. The CLK branches propagate vertically through the center of the core tile to CLKRowDist (RD) modules in every SuperCluster row. Together, the HCLK and CLK branches provide for a low-skew global fanout within the core tile (Figure 2-40 and Figure 2-41).

Figure 2-40 • **CTD, CD, and HD Module Layout**

Figure 2-41 • **HCLK and CLK Distribution within a Core Tile**

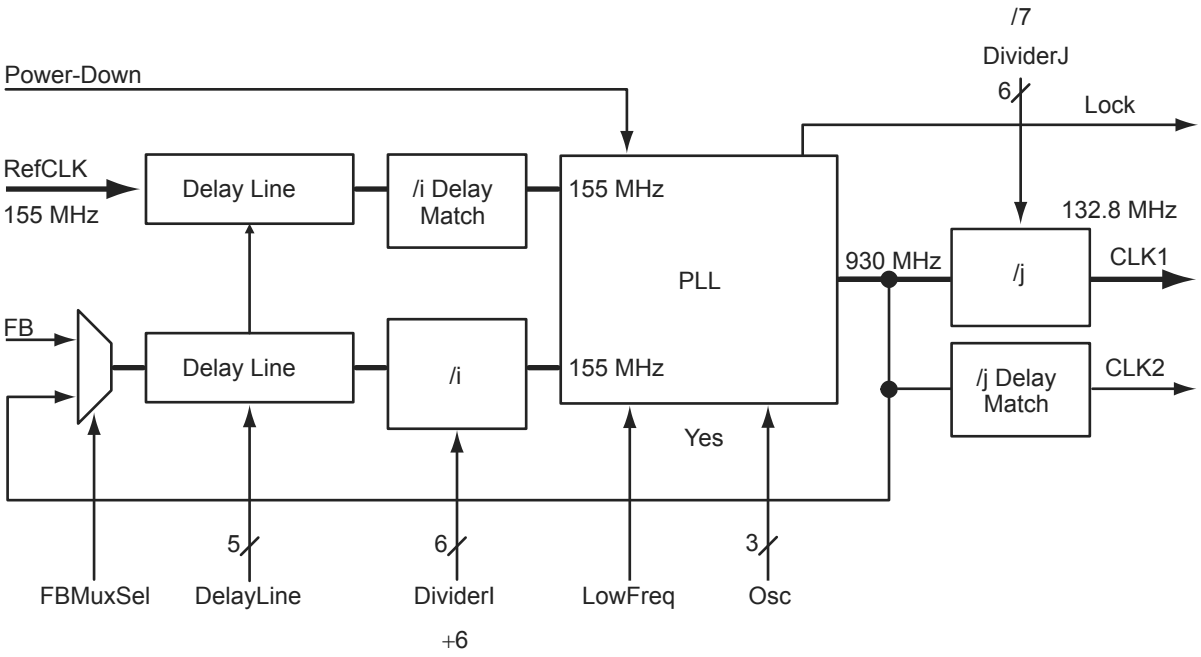


Figure 2-54 • **Using the PLL 155 MHz In, 133 MHz Out**

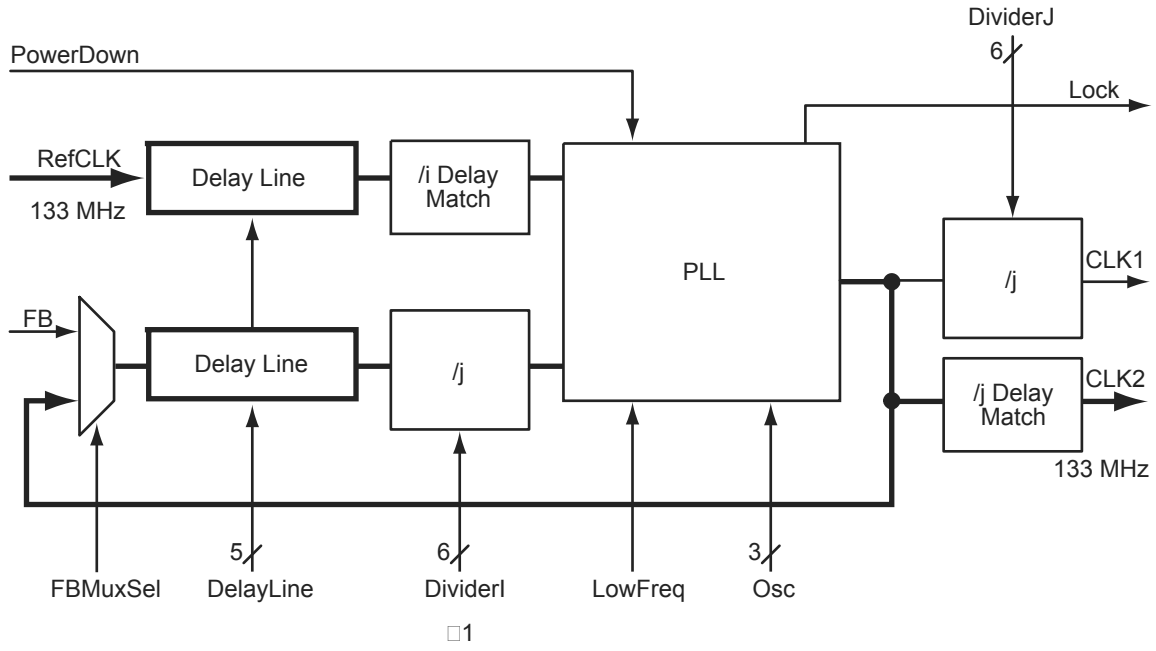


Figure 2-55 • **Using the PLL Delaying the Reference Clock**

Clock

As with RAM configuration, the RCLK and WCLK pins have independent polarity selection.

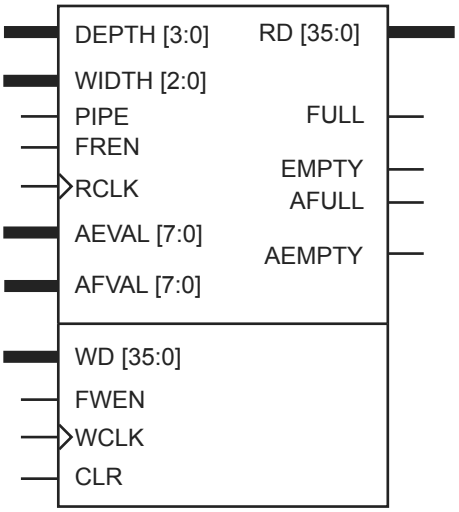


Figure 2-65 • **FIFO Block Diagram**

Table 2-97 • **FIFO Signal Description**

Signal	Direction	Description
WCLK	Input	Write clock (active either edge).
FWEN	Input	FIFO write enable. When this signal is asserted, the WD bus data is latched into the FIFO, and the internal write counters are incremented.
WD[N-1:0]	Input	Write data bus. The value N is dependent on the RAM configuration and can be 1, 2, 4, 9, 18, or 36.
FULL	Output	Active high signal indicating that the FIFO is FULL. When this signal is set, additional write requests are ignored.
AFULL	Output	Active high signal indicating that the FIFO is AFULL.
AFVAL	Input	8-bit input defining the AFULL value of the FIFO.
RCLK	Input	Read clock (active either edge).
FREN	Input	FIFO read enable.
RD[N-1:0]	Output	Read data bus. The value N is dependent on the RAM configuration and can be 1, 2, 4, 9, 18, or 36.
EMPTY	Output	Empty flag indicating that the FIFO is EMPTY. When this signal is asserted, attempts to read the FIFO will be ignored.
AEMPTY	Output	Active high signal indicating that the FIFO is AEMPTY.
AEVAL	Input	8-bit input defining the almost-empty value of the FIFO.
PIPE	Input	Sets the pipe option on or off.
CLR	Input	Active high clear input.
DEPTH	Input	Determines the depth of the FIFO and the number of FIFOs to be cascaded.
WIDTH	Input	Determines the width of the dataword/FIFO, and the number of the FIFOs to be cascaded.

Programming

Device programming is supported through the Silicon Sculptor II, a single-site, robust and compact device programmer for the PC. Up to four Silicon Sculptor IIs can be daisy-chained and controlled from a single PC host. With standalone software for the PC, Silicon Sculptor II is designed to allow concurrent programming of multiple units from the same PC when daisy-chained.

Silicon Sculptor II programs devices independently to achieve the fastest programming times possible. Each fuse is verified by Silicon Sculptor II to ensure correct programming. Furthermore, at the end of programming, there are integrity tests that are run to ensure that programming was completed properly. Not only does it test programmed and nonprogrammed fuses, Silicon Sculptor II also provides a self-test to test its own hardware extensively.

Programming an Axcelerator device using Silicon Sculptor II is similar to programming any other antifuse device. The procedure is as follows:

1. Load the *.AFM file.
2. Select the device to be programmed.
3. Begin programming.

When the design is ready to go to production, Microsemi offers device volume-programming services either through distribution partners or via our In-House Programming Center.

In addition, BP Microsystems offers multi-site programmers that provide qualified support for Axcelerator devices.

For more details on programming the Axcelerator devices, please refer to the *Silicon Sculptor II User's Guide*.

FG676	
AX1000 Function	**Pin Number**
NC	D13
NC	D14
PRA	E13
PRB	B14
PRC	Y14
PRD	AD14
TCK	E5
TDI	B3
TDO	G6
TMS	D4
TRST	A2
VCCA	AB4
VCCA	AF24
VCCA	C1
VCCA	C26
VCCA	J10
VCCA	J11
VCCA	J12
VCCA	J13
VCCA	J14
VCCA	J15
VCCA	J16
VCCA	J17
VCCA	K18
VCCA	K9
VCCA	L18
VCCA	L9
VCCA	M18
VCCA	M9
VCCA	N18
VCCA	N9
VCCA	P18
VCCA	P9
VCCA	R18
VCCA	R9
VCCA	T18

FG676	
AX1000 Function	**Pin Number**
VCCA	T9
VCCA	U18
VCCA	U9
VCCA	V10
VCCA	V11
VCCA	V12
VCCA	V13
VCCA	V14
VCCA	V15
VCCA	V16
VCCA	V17
VCCPLA	E12
VCCPLB	F13
VCCPLC	E15
VCCPLD	G14
VCCPLE	AF15
VCCPLF	AA14
VCCPLG	AF12
VCCPLH	AB13
VCCDA	A11
VCCDA	A3
VCCDA	AB22
VCCDA	AB5
VCCDA	AD10
VCCDA	AD11
VCCDA	AD13
VCCDA	AD16
VCCDA	AD17
VCCDA	B1
VCCDA	B11
VCCDA	B17
VCCDA	C16
VCCDA	D24
VCCDA	E14
VCCDA	P2
VCCDA	P23

FG676	
AX1000 Function	**Pin Number**
VCCIB0	G10
VCCIB0	G8
VCCIB0	G9
VCCIB0	H10
VCCIB0	H11
VCCIB0	H12
VCCIB0	H13
VCCIB0	H9
VCCIB1	G17
VCCIB1	G18
VCCIB1	G19
VCCIB1	H14
VCCIB1	H15
VCCIB1	H16
VCCIB1	H17
VCCIB1	H18
VCCIB2	H20
VCCIB2	J19
VCCIB2	J20
VCCIB2	K19
VCCIB2	K20
VCCIB2	L19
VCCIB2	M19
VCCIB2	N19
VCCIB3	P19
VCCIB3	R19
VCCIB3	T19
VCCIB3	U19
VCCIB3	U20
VCCIB3	V19
VCCIB3	V20
VCCIB3	W20
VCCIB4	W14
VCCIB4	W15
VCCIB4	W16
VCCIB4	W17

FG896	
AX1000 Function	Pin Number
GND	A13
GND	A18
GND	A2
GND	A23
GND	A29
GND	A8
GND	AA10
GND	AA21
GND	AA28
GND	AA3
GND	AB2
GND	AB22
GND	AB29
GND	AB9
GND	AC1
GND	AC30
GND	AE25
GND	AE6
GND	AF26
GND	AF5
GND	AG27
GND	AG4
GND	AH10
GND	AH15
GND	AH16
GND	AH21
GND	AH28
GND	AH3
GND	AJ1
GND	AJ2
GND	AJ22
GND	AJ29
GND	AJ30
GND	AJ9
GND	AK13

FG896	
AX1000 Function	Pin Number
GND	AK18
GND	AK2
GND	AK23
GND	AK29
GND	AK8
GND	B1
GND	B2
GND	B22
GND	B29
GND	B30
GND	B9
GND	C10
GND	C15
GND	C16
GND	C21
GND	C28
GND	C3
GND	D27
GND	D28
GND	D4
GND	E26
GND	E5
GND	H1
GND	H30
GND	J2
GND	J22
GND	J29
GND	J9
GND	K10
GND	K21
GND	K28
GND	K3
GND	L11
GND	L20
GND	M12

FG896	
AX1000 Function	Pin Number
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	M18
GND	M19
GND	N1
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N18
GND	N19
GND	N30
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R28
GND	R3

FG896	
AX1000 Function	Pin Number
NC	K1
NC	K2
NC	L30
NC	M30
NC	N29
NC	T1
NC	U1
NC	W30
NC	Y1
NC	Y2
NC	Y30
PRA	G15
PRB	D16
PRC	AB16
PRD	AF16
TCK	G7
TDI	D5
TDO	J8
TMS	F6
TRST	C4
VCCA	AD6
VCCA	AH26
VCCA	E28
VCCA	E3
VCCA	L12
VCCA	L13
VCCA	L14
VCCA	L15
VCCA	L16
VCCA	L17
VCCA	L18
VCCA	L19
VCCA	M11
VCCA	M20
VCCA	N11

FG896	
AX1000 Function	Pin Number
VCCA	N20
VCCA	P11
VCCA	P20
VCCA	R11
VCCA	R20
VCCA	T11
VCCA	T20
VCCA	U11
VCCA	U20
VCCA	V11
VCCA	V20
VCCA	W11
VCCA	W20
VCCA	Y12
VCCA	Y13
VCCA	Y14
VCCA	Y15
VCCA	Y16
VCCA	Y17
VCCA	Y18
VCCA	Y19
VCCPLA	G14
VCCPLB	H15
VCCPLC	G17
VCCPLD	J16
VCCPLE	AH17
VCCPLF	AC16
VCCPLG	AH14
VCCPLH	AD15
VCCDA	AD24
VCCDA	AD7
VCCDA	AF12
VCCDA	AF13
VCCDA	AF15
VCCDA	AF18

FG896	
AX1000 Function	Pin Number
VCCDA	AF19
VCCDA	C13
VCCDA	C5
VCCDA	D13
VCCDA	D19
VCCDA	D3
VCCDA	E18
VCCDA	F26
VCCDA	G16
VCCDA	T25
VCCDA	T4
VCCIB0	A3
VCCIB0	B3
VCCIB0	J10
VCCIB0	J11
VCCIB0	J12
VCCIB0	K11
VCCIB0	K12
VCCIB0	K13
VCCIB0	K14
VCCIB0	K15
VCCIB1	A28
VCCIB1	B28
VCCIB1	J19
VCCIB1	J20
VCCIB1	J21
VCCIB1	K16
VCCIB1	K17
VCCIB1	K18
VCCIB1	K19
VCCIB1	K20
VCCIB2	C29
VCCIB2	C30
VCCIB2	K22
VCCIB2	L21

FG896	
AX2000 Function	Pin Number
IO124NB2F11	P29
IO124PB2F11	P30
IO125NB2F11	R22
IO125PB2F11	R23
IO127NB2F11	R24
IO127PB2F11	R25
IO128NB2F11	R29
IO128PB2F11	R30
Bank 3	
IO129NB3F12	T27
IO129PB3F12	R27
IO130NB3F12	T29
IO130PB3F12	T30
IO131NB3F12	T22
IO131PB3F12	T23
IO132NB3F12	U26
IO132PB3F12	T26
IO133NB3F12	U24
IO133PB3F12	T24
IO135NB3F12	U23
IO135PB3F12	U22
IO136NB3F12	U29
IO136PB3F12	U30
IO137NB3F12	V28
IO137PB3F12	U28
IO138NB3F12	V27
IO138PB3F12	U27
IO139NB3F13	V25
IO139PB3F13	U25
IO141NB3F13	V23
IO141PB3F13	V22
IO142NB3F13	W29
IO142PB3F13	V29
IO143NB3F13	W26
IO143PB3F13	V26

FG896	
AX2000 Function	Pin Number
IO145NB3F13	W24
IO145PB3F13	V24
IO146NB3F13	W27
IO146PB3F13	W28
IO147NB3F13	Y28
IO147PB3F13	Y27
IO148NB3F13	Y30
IO148PB3F13	W30
IO149NB3F13	Y25
IO149PB3F13	W25
IO150NB3F14	AA29
IO150PB3F14	Y29
IO151NB3F14	AC29
IO152NB3F14	AA26
IO152PB3F14	Y26
IO153NB3F14	Y23
IO153PB3F14	W23
IO154NB3F14	AB30
IO154PB3F14	AA30
IO155NB3F14	AB27
IO155PB3F14	AA27
IO156NB3F14	AC28
IO156PB3F14	AB28
IO157NB3F14	AA24
IO157PB3F14	Y24
IO158NB3F14	AF29
IO158PB3F14	AF30
IO159NB3F14	AB25
IO159PB3F14	AA25
IO160NB3F14	AE30
IO160PB3F14	AD30
IO161NB3F15	AE29
IO161PB3F15	AD29
IO162NB3F15	AD27
IO162PB3F15	AC27

FG896	
AX2000 Function	Pin Number
IO163NB3F15	AC26
IO163PB3F15	AB26
IO164NB3F15	AE28
IO164PB3F15	AD28
IO165NB3F15	AC24
IO165PB3F15	AB24
IO166NB3F15	AG28
IO166PB3F15	AF28
IO167NB3F15	AE26
IO167PB3F15	AD26
IO168NB3F15	AD25
IO168PB3F15	AC25
IO169NB3F15	AF27
IO169PB3F15	AE27
IO170NB3F15	AB23
IO170PB3F15	AA23
Bank 4	
IO171NB4F16	AG29
IO171PB4F16	AG30
IO172NB4F16	AF24
IO172PB4F16	AF25
IO173NB4F16	AG25
IO173PB4F16	AG26
IO174NB4F16	AJ25
IO174PB4F16	AJ26
IO175NB4F16	AK26
IO175PB4F16	AK27
IO176NB4F16	AE23
IO176PB4F16	AE24
IO177NB4F16	AH24
IO177PB4F16	AH25
IO178NB4F16	AD23
IO178PB4F16	AC23
IO179PB4F16	AJ27
IO180NB4F16	AG23

FG896	
AX2000 Function	Pin Number
IO245PB5F23	AG8
IO246NB5F23	AD8
IO246PB5F23	AD9
IO247NB5F23	AG7
IO247PB5F23	AH7
IO248NB5F23	AK5
IO249NB5F23	AJ5
IO249PB5F23	AJ6
IO250NB5F23	AC8
IO250PB5F23	AC9
IO251NB5F23	AH6
IO251PB5F23	AG6
IO252NB5F23	AF6
IO252PB5F23	AF7
IO253NB5F23	AG2
IO253PB5F23	AG1
IO254NB5F23	AE7
IO254PB5F23	AE8
IO255NB5F23	AG5
IO255PB5F23	AH5
IO256NB5F23	AJ4
IO256PB5F23	AK4
Bank 6	
IO257NB6F24	AE4
IO257PB6F24	AF4
IO258NB6F24	AB7
IO258PB6F24	AC7
IO259NB6F24	AD5
IO259PB6F24	AE5
IO260NB6F24	AF1
IO260PB6F24	AF2
IO261NB6F24	AF3
IO261PB6F24	AG3
IO262NB6F24	AC4
IO262PB6F24	AD4

FG896	
AX2000 Function	Pin Number
IO263NB6F24	AD3
IO263PB6F24	AE3
IO264NB6F24	AB6
IO264PB6F24	AC6
IO265NB6F24	AD1
IO265PB6F24	AE1
IO266NB6F24	AA8
IO266PB6F24	AB8
IO267NB6F25	AB5
IO267PB6F25	AC5
IO268NB6F25	AB3
IO268PB6F25	AC3
IO269NB6F25	AC2
IO269PB6F25	AD2
IO270NB6F25	Y7
IO270PB6F25	AA7
IO271NB6F25	AA4
IO271PB6F25	AB4
IO272NB6F25	Y6
IO272PB6F25	AA6
IO273NB6F25	AB1*
IO273PB6F25	AE2*
IO274NB6F25	W8
IO274PB6F25	Y8
IO275NB6F25	Y5
IO275PB6F25	AA5
IO277NB6F25	AA2
IO277PB6F25	AA1
IO278NB6F26	W6
IO278PB6F26	W7
IO279NB6F26	Y3
IO279PB6F26	Y4
IO280NB6F26	V8
IO280PB6F26	V9
IO281NB6F26	Y1

FG896	
AX2000 Function	Pin Number
IO281PB6F26	Y2
IO282NB6F26	V5
IO282PB6F26	W5
IO284NB6F26	V7
IO284PB6F26	V6
IO285NB6F26	W3
IO285PB6F26	W4
IO286NB6F26	U8
IO286PB6F26	U9
IO287NB6F26	W1
IO287PB6F26	W2
IO288NB6F26	U7
IO288PB6F26	U6
IO290NB6F27	U4
IO290PB6F27	V4
IO291NB6F27	U3
IO291PB6F27	V3
IO292NB6F27	T5
IO292PB6F27	U5
IO293NB6F27	U2
IO293PB6F27	V2
IO294NB6F27	T8
IO294PB6F27	T9
IO296NB6F27	T1
IO296PB6F27	U1
IO298NB6F27	T7
IO298PB6F27	T6
IO299NB6F27	R2
IO299PB6F27	T2
Bank 7	
IO300NB7F28	R8
IO300PB7F28	R9
IO302NB7F28	R4
IO302PB7F28	R5
IO303NB7F28	P1

FG896	
AX2000 Function	Pin Number
GND	AK18
GND	AK2
GND	AK23
GND	AK29
GND	AK8
GND	B1
GND	B2
GND	B22
GND	B29
GND	B30
GND	B9
GND	C10
GND	C15
GND	C16
GND	C21
GND	C28
GND	C3
GND	D27
GND	D28
GND	D4
GND	E26
GND	E5
GND	H1
GND	H30
GND	J2
GND	J22
GND	J29
GND	J9
GND	K10
GND	K21
GND	K28
GND	K3
GND	L11
GND	L20
GND	M12

FG896	
AX2000 Function	Pin Number
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	M18
GND	M19
GND	N1
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N18
GND	N19
GND	N30
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R28
GND	R3

FG896	
AX2000 Function	Pin Number
GND	T12
GND	T13
GND	T14
GND	T15
GND	T16
GND	T17
GND	T18
GND	T19
GND	T28
GND	T3
GND	U12
GND	U13
GND	U14
GND	U15
GND	U16
GND	U17
GND	U18
GND	U19
GND	V1
GND	V12
GND	V13
GND	V14
GND	V15
GND	V16
GND	V17
GND	V18
GND	V19
GND	V30
GND	W12
GND	W13
GND	W14
GND	W15
GND	W16
GND	W17
GND	W18

FG896	
AX2000 Function	Pin Number
GND	W19
GND	Y11
GND	Y20
GND/LP	E4
PRA	G15
PRB	D16
PRC	AB16
PRD	AF16
TCK	G7
TDI	D5
TDO	J8
TMS	F6
TRST	C4
VCCA	AD6
VCCA	AH26
VCCA	E28
VCCA	E3
VCCA	L12
VCCA	L13
VCCA	L14
VCCA	L15
VCCA	L16
VCCA	L17
VCCA	L18
VCCA	L19
VCCA	M11
VCCA	M20
VCCA	N11
VCCA	N20
VCCA	P11
VCCA	P20
VCCA	R11
VCCA	R20
VCCA	T11
VCCA	T20

FG896	
AX2000 Function	Pin Number
VCCA	U11
VCCA	U20
VCCA	V11
VCCA	V20
VCCA	W11
VCCA	W20
VCCA	Y12
VCCA	Y13
VCCA	Y14
VCCA	Y15
VCCA	Y16
VCCA	Y17
VCCA	Y18
VCCA	Y19
VCCDA	AD24
VCCDA	AD7
VCCDA	AE15
VCCDA	AE16
VCCDA	AF12
VCCDA	AF13
VCCDA	AF15
VCCDA	AF18
VCCDA	AF19
VCCDA	AH27
VCCDA	AH4
VCCDA	C13
VCCDA	C27
VCCDA	C5
VCCDA	D13
VCCDA	D19
VCCDA	D3
VCCDA	E18
VCCDA	F15
VCCDA	F16
VCCDA	F26

FG896	
AX2000 Function	Pin Number
VCCDA	G16
VCCDA	T25
VCCDA	T4
VCCIB0	A3
VCCIB0	B3
VCCIB0	J10
VCCIB0	J11
VCCIB0	J12
VCCIB0	K11
VCCIB0	K12
VCCIB0	K13
VCCIB0	K14
VCCIB0	K15
VCCIB1	A28
VCCIB1	B28
VCCIB1	J19
VCCIB1	J20
VCCIB1	J21
VCCIB1	K16
VCCIB1	K17
VCCIB1	K18
VCCIB1	K19
VCCIB1	K20
VCCIB2	C29
VCCIB2	C30
VCCIB2	K22
VCCIB2	L21
VCCIB2	L22
VCCIB2	M21
VCCIB2	M22
VCCIB2	N21
VCCIB2	P21
VCCIB2	R21
VCCIB3	AA22
VCCIB3	AH29

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CQ352	
AX500 Function	Pin Number
Bank 0	
IO00PB0F0	343
IO03NB0F0	341
IO03PB0F0	342
IO05NB0F0	337
IO05PB0F0	338
IO07NB0F0	335
IO07PB0F0	336
IO09NB0F0	331
IO09PB0F0	332
IO15NB0F1	325
IO15PB0F1	326
IO17NB0F1	323
IO17PB0F1	324
IO19NB0F1/HCLKAN	319
IO19PB0F1/HCLKAP	320
IO20NB0F1/HCLKBN	313
IO20PB0F1/HCLKBP	314
Bank 1	
IO21NB1F2/HCLKCN	305
IO21PB1F2/HCLKCP	306
IO22NB1F2/HCLKDN	299
IO22PB1F2/HCLKDP	300
IO23NB1F2	289
IO23PB1F2	290
IO24NB1F2	295
IO24PB1F2	296
IO25NB1F2	287
IO25PB1F2	288
IO27NB1F2	283
IO27PB1F2	284
IO29NB1F2	281
IO29PB1F2	282
IO31NB1F2	277
IO31PB1F2	278

CQ352	
AX500 Function	Pin Number
IO35NB1F3	275
IO35PB1F3	276
IO37NB1F3	271
IO37PB1F3	272
IO41NB1F3	269
IO41PB1F3	270
Bank 2	
IO43NB2F4	261
IO43PB2F4	262
IO45NB2F4	259
IO45PB2F4	260
IO47NB2F4	255
IO47PB2F4	256
IO49NB2F4	253
IO49PB2F4	254
IO50NB2F4	247
IO50PB2F4	248
IO51NB2F4	249
IO51PB2F4	250
IO53NB2F5	243
IO53PB2F5	244
IO54NB2F5	241
IO54PB2F5	242
IO55NB2F5	237
IO55PB2F5	238
IO57NB2F5	235
IO57PB2F5	236
IO58NB2F5	231
IO58PB2F5	232
IO59NB2F5	229
IO59PB2F5	230
IO61NB2F5	225
IO61PB2F5	226
IO62NB2F5	223
IO62PB2F5	224

CQ352	
AX500 Function	Pin Number
Bank 3	
IO63NB3F6	217
IO63PB3F6	218
IO64NB3F6	219
IO64PB3F6	220
IO65NB3F6	213
IO65PB3F6	214
IO67NB3F6	207
IO67PB3F6	208
IO68NB3F6	211
IO68PB3F6	212
IO69NB3F6	205
IO69PB3F6	206
IO71NB3F6	201
IO71PB3F6	202
IO73NB3F6	199
IO73PB3F6	200
IO75NB3F7	193
IO75PB3F7	194
IO76NB3F7	195
IO76PB3F7	196
IO77NB3F7	189
IO77PB3F7	190
IO79NB3F7	187
IO79PB3F7	188
IO80NB3F7	183
IO80PB3F7	184
IO81NB3F7	181
IO81PB3F7	182
IO83NB3F7	179
IO83PB3F7	180
Bank 4	
IO85NB4F8	172
IO85PB4F8	173
IO87NB4F8	170

Revision	Changes	Page
Revision 12 (v2.4)	Revised ordering information and timing data to reflect phase out of –3 speed grade options.	
	Table 2-3 was updated.	2
Revision 11 (v2.3)	The "Packaging Data" section is new.	iv
	Table 2-2 was updated.	2-1
	"VCCDA Supply Voltage" was updated.	2-9
	"PRA/B/C/D Probe A, B, C and D" was updated.	2-10
	The "User I/Os" was updated.	2-11
Revision 10 (v2.2)	Figure 1-3 was updated.	1-2
	Table 2-2 was updated.	2-1
	The "Power-Up/Down Sequence" section was updated.	2-1
	Table 2-4 was updated.	2-3
	Table 2-5 was updated.	2-4
	The "Timing Characteristics" section was added.	2-7
	Table 2-7 was updated.	2-7
	Figure 2-1 was updated.	2-8
	The External Setup and Clock-to-Out (Pad-to-Pad) equations in the "Hardwired Clock – Using LVTTL 24 mA High Slew Clock I/O" section were updated.	2-8
	The External Setup and Clock-to-Out (Pad-to-Pad) in the "Routed Clock – Using LVTTL 24 mA High Slew Clock I/O" section were updated.	2-8
	The "Global Pins" section was updated.	2-10
	The "User I/Os" section was updated.	2-11
	Table 2-17 was updated.	2-19
	Figure 2-8 was updated.	2-20
	Figure 2-13 and Figure 2-14 were updated.	2-24
	The following timing parameters were renamed in I/O timing characteristic tables from Table 2-22 to Table 2-60: $t_{IOCLKQ} > t_{ICLKQ}$ $t_{IOCLKY} > t_{OCLKQ}$	2-26 to 2-52
	Timing numbers were updated from Table 2-22 to Table 2-78.	2-26 to 2-69
	The "R-Cell" section was updated.	2-58
	Figure 2-59 was updated.	2-89
	Figure 2-60 was updated.	2-89
	Figure 2-67 was updated.	2-100
	Figure 2-68 was updated.	2-101
	Table 2-89 to Table 2-93 were updated.	2-90 to 2-94
	Table 2-98 to Table 2-102 were updated.	2-102 to 2-106

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